

# TO THE UNCHEON





ΤΗΑΝΚ ΥΟυ to the attendees of the

**2022 IEEE International Symposium** on Electromagnetic Compatibility, **Signal and Power Integrity for** joining us in Spokane, WA.



ON ELECTROMAGNETIC COMPATIBILITY **& SIGNAL/POWER INTEGRITY** 

This is the leading event globally that provides education on EMC, Signal and Power Integrity (SIPI), as well as other related topics such as wireless and automotive. The Symposium features five full days of innovative sessions, interactive workshops/tutorials, experiments and demonstrations, plus social networking events.

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# **2022 IEEE INTERNATIONAL SYMPOSIUM ON ELECTROMAGNETIC COMPATIBILITY &** SIGNAL/POWER INTEGRITY

# AUGUST 1 - 5 <u>SPOKANE, WASHINGTON</u>

# **THURSDAY, AUGUST 4, 2022 SPOKANE CONVENTION CENTER**

**Centennial Ballroom 300AB** 

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# 2022 IEEE EMC+SIPI SPOKANE, WASHINGTON

#### **EMC SOCIETY PRESIDENT'S** MEMORIAL AWARD

(Presented in memory of Henry Ott)

#### Yuanzhuo Liu

For outstanding work as a Ph.D. student in EMC/S PI at Missouri University of Science & Technology

#### **RICHARD R. STODDART AWARD FOR OUTSTANDING PERFORMANCE**

#### **Jun Fan**

For pioneering contributions in understanding radio-frequency interference issues and developing systematic analysis and mitigation approaches in modern wireless devices

#### LAURENCE G. CUMMING AWARD FOR OUTSTANDING SERVICE

#### **Jerry Ramie**

For promoting meaningful EMC immunity testing for utility control products over the last decade

#### HALL OF FAME AWARD

#### Tom Van Doren

For a lifetime of exemplary achievement in EMC education, including hundreds of short courses and the development of the first EMC course at the University of Missouri-Rolla, still being offered nearly 40 years later

#### Liugi R. Koga

For outstanding technical achievement on EMC design methods and promoting stronger ties between EMC academia in Asia and the IEEE EMC Society

#### David V. Giri

For major contributions through R&D efforts in High-Power Electromagnetics including Nuclear Electromagnetic Pulse, High-Power Microwaves, and Ultra-Wideband Systems and Applications

#### **IEEE FELLOW AWARD**

#### Zhiping Yang

For contributions to signal and power integrity in high-performance data center electronics

#### Xiaoning Ye

For contributions to high-speed interconnect design, optimization, and measurement methods

#### **TECHNICAL ACHIEVEMENT AWARD**

#### Stephen Scearce

For outstanding research and design in the signal integrity and power integrity fields

#### James C. West

For a long history of contributing to technical advancements in his RF, microwave, and EMC careers

#### Bo Pu

For outstanding contributions in signal and power integrity solutions for 2.5D/3D integrated circuits

#### SUSTAINED SERVICE TO THE **EMC SOCIETY AWARD** Jan Luiken Ter Haseborg

For his enduring outstanding service to the German EMC Chapter and the EMC Society

#### HONORED MEMBER AWARD **Robert Scully**

For outstanding continued service in leadership for the IEEE EMC Society

**RICHARD B. SCHULZ BEST TRANSACTIONS ON EMC PAPER AWARD** Majid Ahadi Dolatsara, Jose Ale Hejase, Wiren Dale Becker. Jinwoo Kim.

#### Sung Kyu Lim, and Madhavan Swaminathan

"Worst-Case Eye Analysis of High-Speed Channels Based on Bayesian Optimization" IEEE Transactions on Electromagnetic Compatibility Year: 2021, Volume: 63, Issue: 1

#### **RICHARD B. SCHULZ BEST TRANSACTIONS** ON EMC PAPER AWARD -HONORABLE MENTION

#### Frank T. Werner, Jelena Dinkić, Dragan Olćan, Antoniie Diordiević, Milos Prvulović, and Alenka Zajić

"An Efficient Method for Localization of Magnetic Field Sources That Produce High-Frequency Side-Channel Emanations", IEEE Transactions on Electromagnetic Compatibility, Year: 2021. Volume: 63, Issue: 6

#### **MOTOHISA KANDA AWARD FOR MOST** CITED (2017-2021) TRANSACTIONS ON **EMC PAPER AWARD**

#### Saptarshi Ghosh and Kumar Vaibhav Srivastava

"Broadband Polarization-Insensitive Tunable Frequency Selective Surface for Wideband Shielding", IEEE Transactions on Electromagnetic Compatibility, Year: 2018, Volume: 60, Issue: 1, Cited by: Papers (65)

#### **BEST EMC SYMPOSIUM PAPER AWARD**

Shengxuan Xia, Jun Fan, and Chulsoon Hwang "Clock Duty Cycle Tuning for Desense Mitigation in Modulation - Involved Cases"

#### **BEST EMC SYMPOSIUM PAPER AWARD –** HONORABLE MENTION

#### Fuwei Ma. Ruiiie He. Sameer Waluni. Tamar Makharashvili, Chulsoon Hwang, Darvl Beetner. Brian Booth. and Kerry Martin "Predicting Radiated Emissions from a Complex Transportation System Wiring Harness"

#### **BEST SIPI SYMPOSIUM PAPER AWARD** Chaofeng Li, Bivao Zhao, Bo Pu, Xu Wang, **DongHyun Kim, and Jun Fan**

"PEEC-Based On-Chip PDN Impedance Modeling Using Lavered Green's Function"

#### BEST SIPI SYMPOSIUM PAPER AWARD -HONORABLE MENTION

Yang Wu, Wenwu Wang, Yinghua Ye, Yinglei Ren. Michael Leddige, and Xiaoning Ye "Analysis of Noise Coupling from Switching

#### Voltage Regulator and Power Distribution Network to Differential Stripline Traces"

#### **BEST EMC SYMPOSIUM STUDENT** PAPER AWARD

Wei Zhang, Rui Mi, and Victor Khilkevich "3D Printed Multilaver Microwave Absorber"

#### **BEST EMC SYMPOSIUM STUDENT** PAPER AWARD – HONORABLE MENTION

#### James Hunter, Shengxuan Xia, Aaron Harmon, Mohamed Z.M. Hamdalla. Ahmed M. Hassan. Victor Khilkevich, and Darvl G. Beetner "A Segmentation Strategy for Structures with

Common Mode Coupling"

#### **BEST SIPI SYMPOSIUM STUDENT** PAPER AWARD

#### Jiangshuai Li, Yuanzhuo Liu, Liang Liu, Shengxuan Xia. Scott Hinaga. and Victor Khilkevich

"Dielectric Loss Tangent Extraction Using Two Single-Ended Striplines of Different Width'

#### **BEST SIPI SYMPOSIUM STUDENT** PAPER AWARD - HONORABLE MENTION Yifan Ding, Matthew S. Doyle, Samuel Connor, Dale Becker, and James L. Drewniak "Physics-Based Modeling for Determining

Transient Current Flow in Multi-Laver PCB PI Desians"

#### STUDENT EMC HARDWARE DESIGN **COMPETITION AWARD**

#### Lukasz Nowarkiewicz, Paulina Sznajdrowska, and Nikoloz Glonti. Poznan University of **Technology**, Poland "Charging the Phone Adventure"

## STUDENT EMC HARDWARE DESIGN Competition Award — **HONORABLE MENTION**

#### Ameya Ramadurgakar,

University of Colorado, Boulder "Dr. Strange Signal or How I Learned to Stop Worrying on PI and Learnt the Hacks"

#### **YOUNG PROFESSIONAL AWARD**

Pavithrakrishnan Radhakrishnan For outstanding services to the IEEE EMC Society, especially in the Benelux region, and to the IEEE EMC Education Committee

#### **CHAPTER OF THE YEAR AWARD** IEEE EMC Israel Chapter

#### MOST IMPROVED CHAPTER AWARD **IEEE EMC Poland Chapter**

#### SYMPOSIUM CHAIR AWARD **Alistair Duffv**

For his outstanding chairmanship of the 2021 Joint IEEE EMC+SIPI and EMC Europe Symposia

### www.emc2022.emcss.org **#IEEE ESP22**

# **CERTIFICATE OF RECOGNITION**

**Emily Nagel** 

For outstanding service as the 2022 IEEE EMC + SIPI Companion Chair

**Bonnie Brench** 

For outstanding service as the 2022 IEEE EMC + SIPI Registration Chair

**Stephanie Zaiac** For outstanding service as the 2022 IEEE EMC + SIPI Secretary and Youth Program Chair

**Zhiping Yang** 

Xiaoning Ye

# **CERTIFICATE OF APPRECIATION**

**Christos Christopoulos** For outstanding and dedicated service as the EMC Magazine Associate Editor for Theme Papers

Ji Chen and Akimasa Hirata

For outstanding contributions as Guest Editors of the IEEE Transactions on EMC

Krzvsztof Sieczkarek For his outstanding efforts and support of the Polish EMC Chapter and the EMC Society

Zhiping Yang, Flavio Canavero, Xiang Cui,

D. V. Giri, Bhyrav Mutnury, Alpesh Bhobe,

For significant contribution to the administra-

tion and overall success of the EMC Society as

Ross Carlton, Caroline Chan, Tom Braxton,

For significant contribution to the administration and overall success of the EMC Society as Members of the Board of Directors (2019-2021)

For outstanding contributions as Associate

Editors of the Transactions on EMC

Distinguished Lecturers (2020-2021)

Henry Benitez, Yuki Fukumoto,

Pavithrakrishnan Radhakrishnan.

Mohammad Kameli, and Zhao Chen

For outstanding performance revitalizing the

Student EMC Hardware Design Competition

For outstanding service as the 2022 IEEE EMC+SIPI Vice-Chair

For outstanding service as the 2022 IEEE

For outstanding service as the 2022 IEEE

EMC+SIPI Symposium Technical Program Chair

and Michael McInerney

and Davy Pissoort

**Dennis Lewis** 

Stephen Scearce

Frank Leferink

EMC+SIPI Treasurer

and Erping Li

Alistair Duffy For outstanding service as the 2022 IEEE EMC+SIPI Exhibition/Sponsorship Chair

Flavia Grassi and John Maas For outstanding service as the 2022 IEEE EMC+SIPI Workshops and Tutorials Co-Chairs

Mark Steffka Chair

**Jacob Nixon and Gabe Alcala** For outstanding service as the 2022 IEEE EMC+SIPI Demonstrations and Experiments Co-Chairs

Vignesh Raiamani For outstanding service as the 2022 IEEE EMC+SIPI Publications Chair

**Alpesh Bhobe** 

Patrick DeRov

**Ross Carlton** 

Susanne Vogel For outstanding service as the 2022 IEEE EMC+SIPI Marketing Chair

## **CONGRATULATIONS TO THE FOLLOWING EMC SOCIETY MEMBERS** WHO WERE ELECTED TO THE IEEE FELLOW GRADE IN 2022. THESE MEMBERS ARE SHOWN BELOW WITH THEIR EVALUATING SOCIETY.

Hongsheng Chen, Antennas and Propagation

For outstanding service as the 2022 IEEE EMC+SIPI Technical Papers Co-Chair EMC

For outstanding service as the 2022 IEEE EMC+SIPI Technical Papers Co-Chair SIPI

**Todd Hubing and Francesca Maradei** For outstanding service as the 2022 IEEE EMC+SIPI Special Sessions Co-Chairs

For outstanding service as the 2022 IEEE EMC+SIPI Clayton R. Paul Global University

For outstanding service as the 2022 IEEE EMC+SIPI Volunteer Chair

For outstanding service as the 2022 IEEE EMC+SIPI Young Professionals Chair

For outstanding service as the 2022 IEEE EMC+SIPI Standards Week Chair

# **EMC TRANSACTIONS: 2021 DISTINGUISHED REVIEWERS**

Xing Chang Wei Zheijang University, China

Flavia Grassi Politecnico di Milano, Italy

Giordano Spadacini Politecnico di Milano, Italy

Yoshihiro Baba Doshisha University, Japan

Francesco de Paulis University of L'Aquila, Italy

Akivoshi Tatematsu Central Research Institute of Electric Power Industry, Japan

Mathias Magdowski Otto-von-Guericke Universität. Germanv

> William Radaskv Metatech Corporation, USA

**Giulio Antonini** University of L'Aquila, Italy

Niek Moonen University of Twente, Netherlands

**Giampiero Lovat** University of Rome "La Sapieza", Italy

# **IN MEMORIAM**

Henry Ott: 1936-2021 Don Sweeney: 1941-2021 Bud Taggart: 1927-2021 Herb Mertel: 1931-2021 Len Carlson: 1930-2022 Wladyslaw Moroń: 1932-2022 Donald Weiner: 1934-2021 William Gamble: 1940-2021 Bill Limburg: 1938-2021 **Cees Keyer:** 1963-2022

**Tommaso Isernia.** Antennas and Propagation

Mario Paolone. Power and Energy